

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE OF COMMISSION OF COMMISSION OF COLUMN OF COMMISSION OF COLUMN OF CO

In re Application of

Bednar et al.

Serial No.: 10/065,201

Group Art Unit: 2825

Filed: September 25, 2002

Examiner: Unknown

VOLTAGE ISLAND CHIP IMPLEMENTATION

Assistant Commissioner of Patents Washington, D.C. 20231

SUBMISSION OF FORMAL DRAWINGS

Sir:

For:

Submitted herewith are fifteen (15) sheets of formal drawings comprising Figs. 1-16 for the above-referenced patent application. Acknowledgment of receipt is respectfully requested. Please substitute these formal drawings for the drawings which were filed with the application.

Respectfully Submitted,

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Date: 1/25/02

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CERTIFICATE OF MAILING BY FIRST CLASS MAIL (37 CFR 1.8) Applicant(s): Bednar et al. Docket No. BUR920020056			
Serial No. 10/065,201	Filing Date September 25, 2002	Examiner DEC -4	Group Art Unit
Invention: VOLTAGE ISLAND CHIP IMPLEMENTATION DEC 0 2 2002.			
I hereby certify that this Submission of Formal Drawings			
(Identify type of correspondence) is being deposited with the United States Postal Service as first class mail in an envelope addressed to: The			
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